

AO3404A

N-Channel Enhancement Mode Field Effect Transistor

General Description

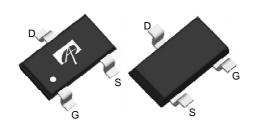
The AO3404A uses advanced trench technology to provide excellent $R_{\text{DS(ON)}}$ and low gate charge. This device is suitable for use as a load switch or in PWM applications. The source leads are separated to allow a Kelvin connection to the source, which may be used to bypass the source inductance.

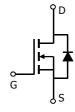
Features

$$\begin{split} &V_{DS}\left(V\right) = 30V \\ &I_{D} = 5.8A & (V_{GS} = 10V) \\ &R_{DS(ON)} < 25m\Omega & (V_{GS} = 10V) \\ &R_{DS(ON)} < 35m\Omega & (V_{GS} = 4.5V) \end{split}$$



SOT23
Top View Bottom View





Absolute Maximum Ratings T_A=25℃ unless otherwise noted

Parameter		Symbol	Maximum	Units	
Drain-Source Voltage		V _{DS}	30	V	
Gate-Source Voltage		V_{GS}	±20	V	
Continuous Drain	T _A =25℃		5.8		
Current A,F	T _A =70℃	I _D	4.9	A	
Pulsed Drain Current ^B		I _{DM}	64	1	
	T _A =25℃	Р	1.4	W	
Power Dissipation	T _A =70℃	$-P_{D}$	0.9		
Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 150	C	

Thermal Characteristics								
Parameter	Symbol	Тур	Max	Units				
Maximum Junction-to-Ambient A	t ≤ 10s	$R_{\theta JA}$	65	90	℃/W			
Maximum Junction-to-Ambient A	Steady-State	IN _θ JA	85	125	°C/W			
Maximum Junction-to-Lead ^C	Steady-State	$R_{\theta JL}$	63	80	℃/W			

Electrical Characteristics (T_J=25℃ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units				
STATIC PARAMETERS										
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =250μA, V _{GS} =0V	30			V				
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =30V, V _{GS} =0V			1	μΑ				
		T _J =55℃			5	μι				
I_{GSS}	Gate-Body leakage current	V_{DS} =0V, V_{GS} = ±20V			100	nA				
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$ $I_{D}=250\mu A$	1.5	2.1	2.6	V				
$I_{D(ON)}$	On state drain current	V_{GS} =4.5V, V_{DS} =5V	64			Α				
	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =5.8A		18.4	25	mΩ				
$R_{DS(ON)}$		T _J =125℃		26.2	36	11122				
		V_{GS} =4.5V, I_{D} =4.8A		24.5	35	mΩ				
g _{FS}	Forward Transconductance	VDS=5V, ID=5.8A		22		S				
V_{SD}	Diode Forward Voltage	I _S =1A,V _{GS} =0V		0.75	1	V				
Is	Maximum Body-Diode Continuous Curr			2.5	Α					
DYNAMIC	PARAMETERS		•		•	•				
C _{iss}	Input Capacitance			373	448	pF				
C _{oss}	Output Capacitance	V_{GS} =0V, V_{DS} =15V, f=1MHz		67		pF				
C _{rss}	Reverse Transfer Capacitance			41		pF				
R_g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz		1.8	2.8	Ω				
SWITCHI	NG PARAMETERS	•								
Q _g (10V)	Total Gate Charge			7.1	11	nC				
Q _g (4.5V)	Total Gate Charge	VGS=10V, VDS=15V, ID=5.8A		3.3		nC				
Q_{gs}	Gate Source Charge	- VGS=10V, VDS=15V, ID=5.6A		1.4		nC				
Q_{gd}	Gate Drain Charge]		1.7		nC				
t _{D(on)}	Turn-On DelayTime			4.5	6.5	ns				
t _r	Turn-On Rise Time	V_{GS} =10V, V_{DS} =15V, R_{L} =2.6 Ω ,		2.4		ns				
t _{D(off)}	Turn-Off DelayTime	$R_{GEN}=3\Omega$		14.8		ns				
t _f	Turn-Off Fall Time	1		2.5		ns				
t _{rr}	Body Diode Reverse Recovery Time	I _F =5.8A, dI/dt=100A/μs		10.5	12.6	ns				
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =5.8A, dI/dt=100A/μs		4.5		nC				

A: The value of R $_{\theta JA}$ is measured with the device mounted on 1 in 2 FR-4 board with 2 oz. Copper, in a still air environment with T $_A$ =25 $^\circ$ C. The value in any given application depends on the user's specific board design. The current rating is based on the t $\, \leq \,$ 10s thermal resistance rating.

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B: Repetitive rating, pulse width limited by junction temperature.

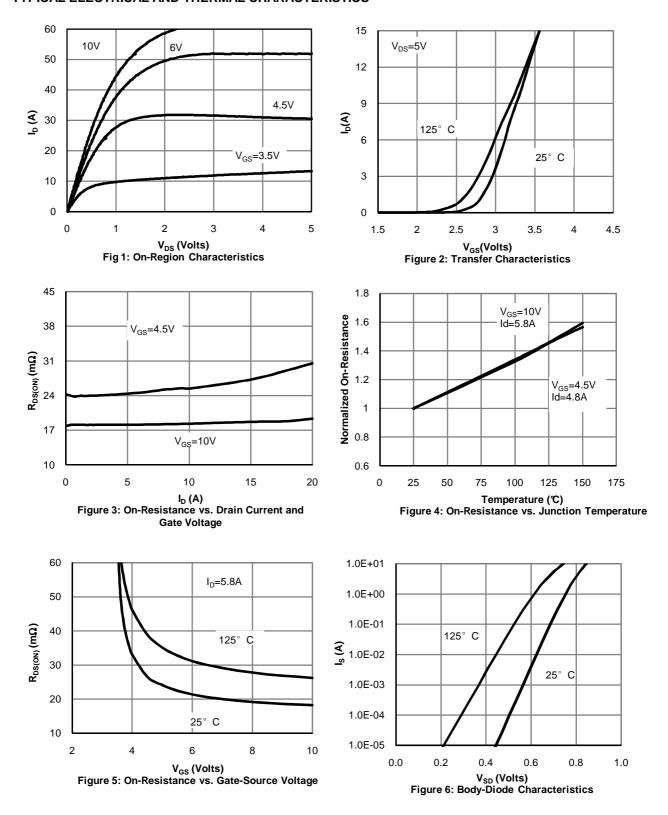
C. The R $_{\theta JA}$ is the sum of the thermal impedence from junction to lead R $_{\theta JL}$ and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using <300 µs pulses, duty cycle 0.5% max.

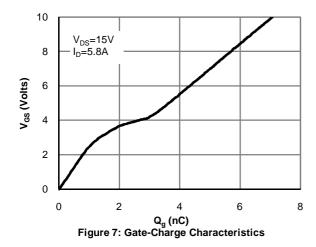
E. These tests are performed with the device mounted on 1 in ² FR-4 board with 2oz. Copper, in a still air environment with T_A=25° C. The SOA curve provides a single pulse rating.

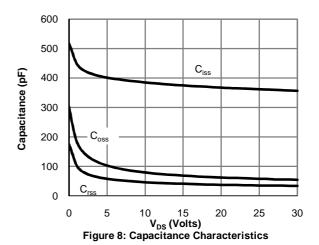
F.The current rating is based on the t≤ 10s thermal resistance rating.

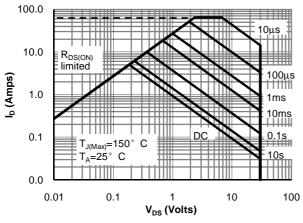
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



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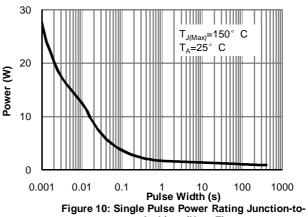
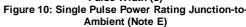


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)



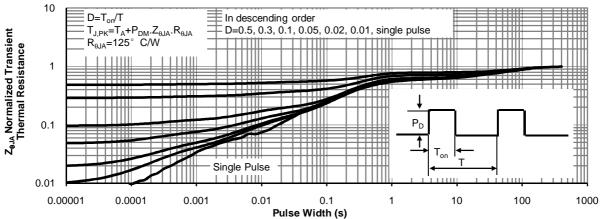


Figure 11: Normalized Maximum Transient Thermal Impedance